ICS-8550
Rugged XMC Module Provides 210 MHz ADCs and Virtex-4 Processing Power

The ICS-8550 is an XMC form factor digital receiver module intended for Software Defined Radio applications such as communications and radar in benign and hostile environments. The card has been optimized to provide high performance signal conversion capability to XMC equipped host cards such as the V4DSP Dual Virtex-4 & PowerPC Processor. The combination of high performance ADC and FPGA resources allows VHF and UHF signals to be digitized and processed directly on the XMC module. Algorithms such as digital down conversion, FFT, and filtering can be developed to execute in the Virtex-4 FPGA, using the included Hardware Development Kit (HDK). The module is available in five levels of ruggedization, three for air-cooled environments and two for conduction cooled environments. Details of the environmental specifications are available from our web site.

The DDC core provides for programmable decimation ratios of 1 through 16, with real or complex outputs. Output selection options include the high-speed serial outputs or the PCI bus. The 18-bit filter coefficients can be independently programmed for each channel; a standard coefficient set is included in the design. Also provided are input and output gain controls, a peak signal detector and a test signal capability.

The ICS-8550 provides the user with up to eight lanes of high-speed serial I/O for communication with XMC equipped carrier cards such as the V4DSP at rates up to 2.5 GBytes/s. The 64/66 PCI interface provides sustained data rates in excess of 400 MBytes/s, while the Pn4 user I/O port allows the user to define direct point to point connections to the FPGA, eliminating interrupt latencies. The latter two interfaces may be used for applications in which the XMC interface cannot be used.

Optional front panel connectors include an 8-plug Samtec GRF1-J connector (for ruggedization levels 1, 2 and 3), or 8 individual MMCX connectors (for ruggedization levels 4 & 5).

The ICS-8550 HDK includes two core designs, a default logic core and a programmable, dual channel, Digital Down-Converter (DDC) IP core. The default logic core, designed to provide minimum occupancy of the FPGA, includes an A/D interface and data buffering to the high-speed serial outputs and provides a basis for customers to program their own functionality.
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Specifications

Analog Input
- 2 analog inputs, transformer-coupled, AD9430, 12-bit
- Max. sample rate 210 MHz
- 50 Ohm input impedance
- Full scale input +7.7dBm or +1.7dBm, software-selectable
- Input bandwidth 2 – 700 MHz (−3dB)
- Max. sampling rate 210 MHz
- Internal sampling clock 409.6 MHz VCXO with dividers
- Min. sampling rate 60 MHz
- Ext. clock LV/TTL or sine wave 0dBm min., 20dBm max., 10 – 420 MHz
- Ext. trigger LVCMOS, rising or falling edge
- SINAD >65dB @ fin <70 MHz
- SFDR >75dB
- Cross-talk <-80dB

General Specifications
- VITA 42 XMC compliant, 8 lanes

Onboard Resources
- Xilinx Virtex-4 FPGA (XC4VFX60 or XC4VFX100)
- Two IP cores available (default core and programmable DDC core)
- 8-plug Samtec GRF1-J connector (Levels 1 – 3)
- 8 individual MMX connectors (Level 4 & 5)

I/O Specifications
- PCI 2.2 64-bit, 66 MHz PCI bus interface, universal signaling
- 32 user configurable LVDS I/O pairs directly connect P4 to FPGA

Environmental
- Five build levels available. Air and conduction cooled versions
- -60 to +85 degrees C operating temperature
- 95% non-condensing humidity

Block Diagram

About GE Fanuc Embedded Systems
GE Fanuc Embedded Systems is a leading global provider of embedded computing solutions for a wide range of industries and applications. Our comprehensive product offering includes many types of I/O, single board computers, high performance signal processors, fully integrated, rugged systems including flat panel displays, plus high speed networking and communications products. The company is headquartered in the U.S. and has design, manufacturing and support offices throughout the world. Whether you’re looking for one of our standard products or a fully custom solution, GE Fanuc Embedded Systems has the breadth, experience and 24x7 support to deliver what you need. For more information, visit www.gefanucembedded.com.

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Additional Resources
For more information, please visit the GE Fanuc Embedded Systems web site at:
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